wherein each of R_a, R_b, R_c are independently selected from the group comprising: a hydroxylated aliphatic side chain; an epoxy glycol; an ethoxy ether; and a glycol ether.

23 35. (Added) The device of claim 22 34, wherein R_a, R_b, R_c further comprises an adduct of glycol ether and a bisphenol glycol epoxy.

24 36. (Added)The device of claim 22 34, wherein R_a, R_b, R_c further comprises an adduct of an epoxy glycol and an amine.

25 37. (Added) The device of claim 22 34, wherein R_a, R_b, R_c further comprises an adduct of a glycol ether and a cycloaliphatic epoxy.

26 38. (Added) The device of claim 22 34, wherein R_a, R_b, R_c further comprises and an adduct of hydroxyethyl side chain and a cycloaliphatic epoxy.

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27 39. (Added) The device of claim 25 37, wherein the adduct is an oxybis(cyclopentene oxide).

28 40. (Added) The device of claim 24 36, wherein the amine an oxydianiline .

29 41. (Added) The device of claim 28 40, wherein the adduct is an hydroxylamine.

30 42. (Added) The device of claim 26 38, wherein the adduct is an oxybiscyclopentene.

31 43. (Added) The device of claim 22 34, wherein the polymer further comprises a bisphenol A glycidyl epoxy.

32 44. (Added) The device of claim 22 34, wherein the polymer further comprises a bis 3,4 epoxycyclohexylmethyl adipate.

33 45. (Added) The device of claim 22 34, wherein the polymer further comprises a trishydroxy-ethylisocyanurate.

34 46. (Added) The device of claim 22 34, wherein the electronic device further comprises a substrate.

35 47. (Added) The device of claim 34 46, wherein the polymer forms an interface with the